TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LVX245F,TC74LVX245FT

Octal Bus Transceiver

The TC74LVX245F/ FT is a high-speed CMOS octal bus transceiver fabricated using silicon gate CMOS technology. Designed for use in 3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

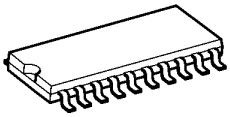
These devices are suitable for low-voltage and battery operated systems.

It is intended for two-way asynchronous communication between data busses.

The direction of data transmission is determined by the level of the DIR input. The enable input ($\overline{G}$) can be used to disable the device so that the busses are effectively isolated.

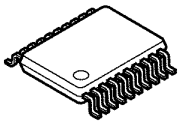
All inputs are equipped with protection circuits against static discharge.

TC74LVX245F



SOP20-P-300-1.27A

TC74LVX245FT



TSSOP20-P-0044-0.65A

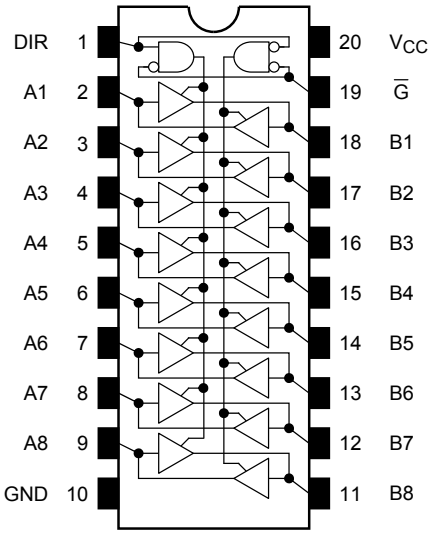
Weight
SOP20-P-300-1.27A : 0.22 g (typ.)
TSSOP20-P-0044-0.65A : 0.08 g (typ.)

Features (Note)

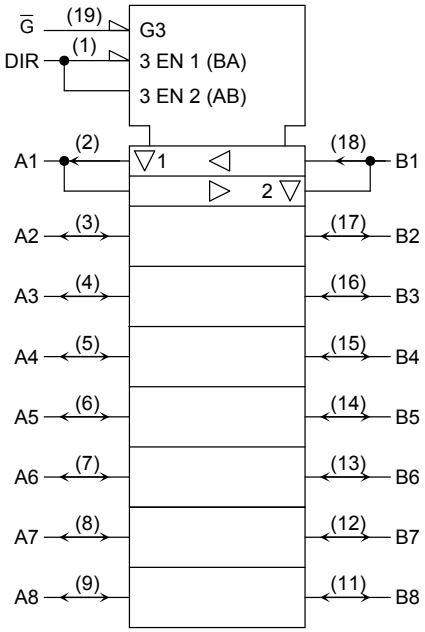
- High-speed: t_{pd} = 4.7 ns (typ.) (V_{CC} = 3.3 V)
- Low power dissipation: I_{CC} = 4 μA (max) (Ta = 25°C)
- Input voltage level: V_{IL} = 0.8 V (max) (V_{CC} = 3 V)
  V_{IH} = 2.0 V (min) (V_{CC} = 3 V)
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Low noise: V_{OLP} = 0.8 V (max)
- Pin and function compatible with 74HC245

Note: Do not apply a signal to any bus pins when it is in the output mode. Damage may result.
All floating (high impedance) bus pins must have their input levels fixed by means of pull-up or pull-down resistors.
A parasitic diode is formed between the bus and V_{CC} terminals. Therefore bus terminal can not be used to interface 5-V to 3-V systems directly.

Pin Assignment (top view)



IEC Logic Symbol



Truth Table

Inputs		Outputs	Function	
$\overline{G}$	DIR		A-Bus	B-Bus
L	L	A = B	Output	Input
L	H	B = A	Input	Output
H	X	Z	High impedance	

X: Don't care

Z: High impedance

Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CC}	−0.5 to 7.0	V
DC input voltage (DIR, $\overline{G}$)	V_{IN}	−0.5 to 7.0	V
DC bus I/O voltage	$V_{I/O}$	−0.5 to V_{CC} + 0.5	V
Input diode current	I_{IK}	−20	mA
Output diode current	I_{OK}	±20	mA
DC output current	I_{OUT}	±25	mA
DC V_{CC}/ground current	I_{CC}	±75	mA
Power dissipation	P_D	180	mW
Storage temperature	T_{stg}	−65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	2.0 to 3.6	V
Input voltage (DIR, $\overline{G}$)	V_{IN}	0 to 5.5	V
Bus I/O voltage	$V_{I/O}$	0 to V_{CC}	V
Operating temperature	T_{opr}	−40 to 85	°C
Input rise and fall time	dt/dv	0 to 100	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either VCC or GND. Please connect both bus inputs and the bus outputs with VCC or GND when the I/O of the bus terminal changes by the function. In this case, please note that the output is not short-circuited.

Electrical Characteristics

DC Characteristics

Characteristics		Symbol	Test Condition		Ta = 25°C				Ta = −40 to 85°C		Unit
					V_{CC} (V)	Min	Typ.	Max	Min	Max	
Input voltage	H-level	V_{IH}	—		2.0	1.5	—	—	1.5	—	V
					3.0	2.0	—	—	2.0	—	
					3.6	2.4	—	—	2.4	—	
	L-level	V_{IL}	—		2.0	—	—	0.5	—	0.5	
					3.0	—	—	0.8	—	0.8	
					3.6	—	—	0.8	—	0.8	
Output voltage	H-level	V_{OH}	V_{IN} = V_{IH} or V_{IL}	I_{OH} = −50 μA	2.0	1.9	2.0	—	1.9	—	V
				I_{OH} = −50 μA	3.0	2.9	3.0	—	2.9	—	
				I_{OH} = −4 mA	3.0	2.58	—	—	2.48	—	
	L-level	V_{OL}	V_{IN} = V_{IH} or V_{IL}	I_{OL} = 50 μA	2.0	—	0	0.1	—	0.1	
				I_{OL} = 50 μA	3.0	—	0	0.1	—	0.1	
				I_{OL} = 4 mA	3.0	—	—	0.36	—	0.44	
3-State output Off-state current		I_{OZ}	V_{IN} = V_{IH} or V_{IL} V_{OUT} = V_{CC} or GND		3.6	—	—	±0.25	—	±2.5	μA
Input leakage current		I_{IN}	V_{IN} = 5.5 V or GND		3.6	—	—	±0.1	—	±1.0	μA
Quiescent supply current		I_{CC}	V_{IN} = V_{CC} or GND		3.6	—	—	4.0	—	40.0	μA

AC Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = −40 to 85°C		Unit
			V_{CC} (V)	C_L (pF)	Min	Typ.	Max	Min	Max	
Propagation delay time	t_{pLH}	—	2.7	15	—	6.1	10.7	1.0	13.5	ns
				50	—	8.6	14.2	1.0	17.0	
	t_{pHL}		3.3 ± 0.3	15	—	4.7	6.6	1.0	8.0	
				50	—	7.2	10.1	1.0	11.5	
Output enable time	t_{pZL}	R_L = 1 kΩ	2.7	15	—	9.0	16.9	1.0	20.5	ns
				50	—	11.5	20.4	1.0	24.0	
	t_{pZH}		3.3 ± 0.3	15	—	7.1	11.0	1.0	13.0	
				50	—	9.6	14.5	1.0	16.5	
Output disable time	t_{pLZ}	R_L = 1 kΩ	2.7	50	—	11.5	18.0	1.0	21.0	ns
	t_{pHZ}		3.3 ± 0.3	50	—	9.6	12.8	1.0	14.5	
Output to output skew	t_{osLH}	(Note 1)	2.7	50	—	—	1.5	—	1.5	ns
	t_{osHL}		3.3 ± 0.3	50	—	—	1.5	—	1.5	
Input capacitance	C_{IN}	DIR, $\overline{G}$		(Note 2)	—	4	10	—	10	pF
Bus input capacitance	$C_{I/O}$	An, Bn			—	8	—	—	—	pF
Power dissipation capacitance	C_{PD}			(Note 3)	—	21	—	—	—	pF

Note 1: Parameter guaranteed by design.
($t_{osLH} = |t_{pLHm} - t_{pLHn}|$, $t_{osHL} = |t_{pHLm} - t_{pHLn}|$)

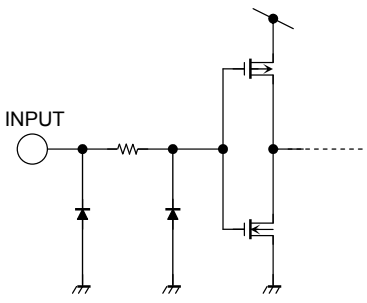
Note 2: Parameter guaranteed by design.

Note 3: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.
Average operating current can be obtained by the equation:
$I_{CC\ (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8$ (per bit)

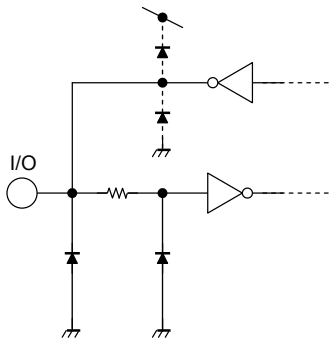
Noise Characteristics (Ta = 25°C, input: $t_r = t_f = 3$ ns, $C_L = 50$ pF)

Characteristics	Symbol	Test Condition	Typ.	Limit	Unit
		V_{CC} (V)			
Quiet output maximum dynamic V_{OL}	V_{OLP}	—	3.3	0.5	0.8	V
Quiet output minimum dynamic V_{OL}	V_{OLV}	—	3.3	−0.5	−0.8	V
Minimum high level dynamic input voltage V_{IH}	V_{IHD}	—	3.3	—	2.0	V
Maximum low level dynamic input voltage V_{IL}	V_{ILD}	—	3.3	—	0.8	V

Input Equivalent Circuit

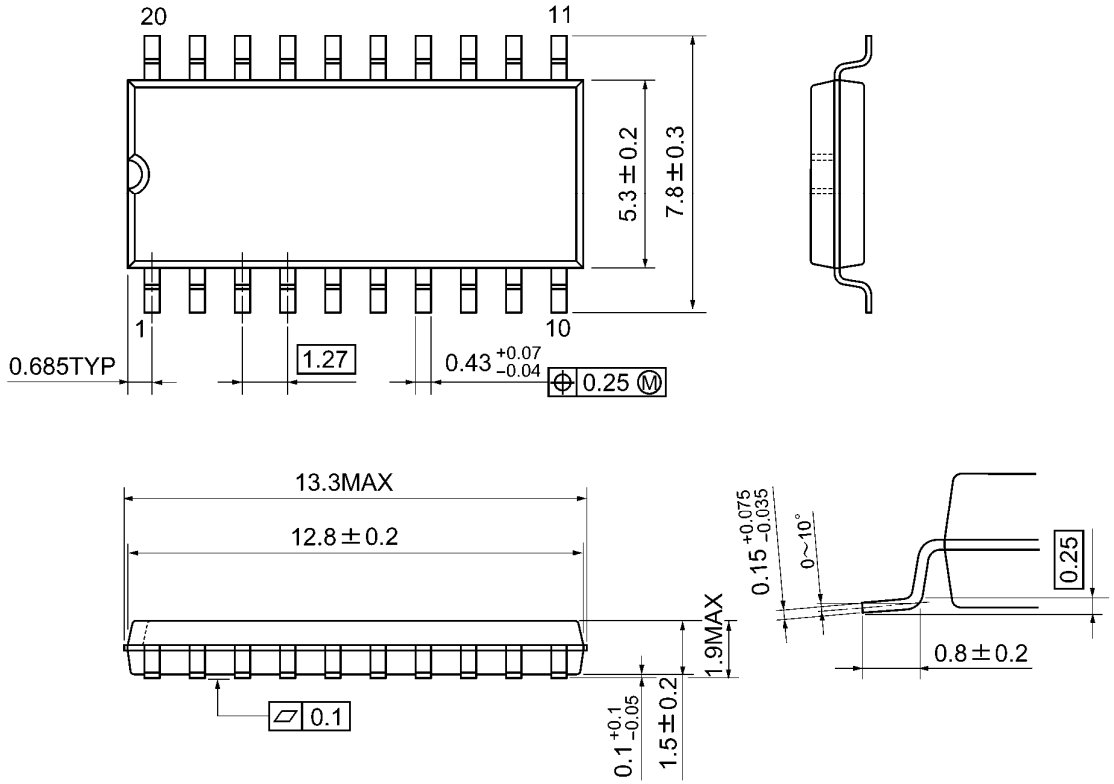


Bus Terminal Equivalent Circuit (An, Bn)



Package Dimensions

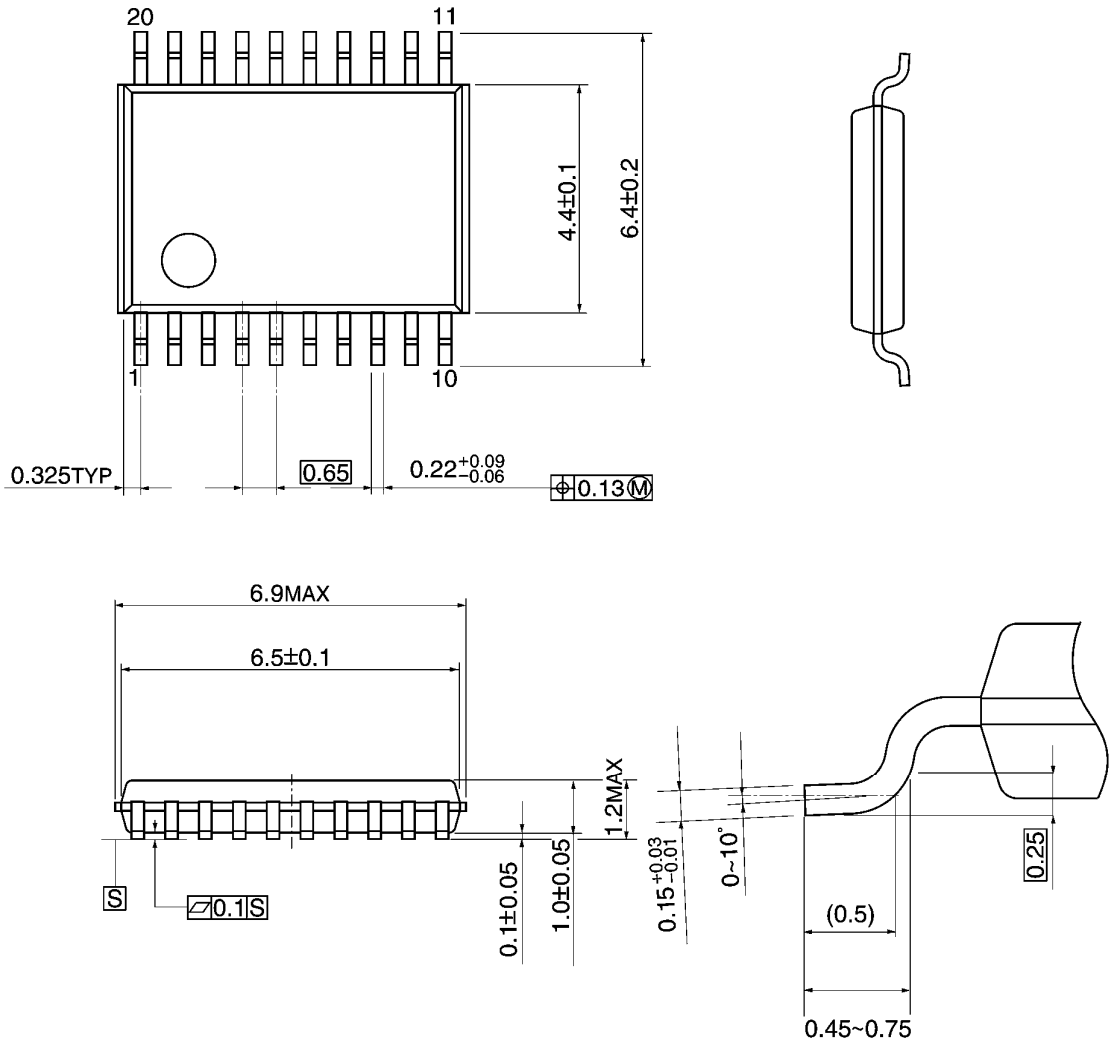
SOP20-P-300-1.27A Unit: mm



Weight: 0.22 g (typ.)

Package Dimensions

TSSOP20-P-0044-0.65A Unit: mm



Weight: 0.08 g (typ.)

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